PATENT ASSIGNMENT

Electronic Version v08 Stylesheet Version v02

SUBMISSION TYPE:

NEW ASSIGNMENT

APPLICATION NUMBER

10/907924

ASSIGNMENT OF ASSIGNOR'S INTEREST

CONVEYING PARTY DATA

Name	Execution Date	
Wei-Chi Ting	2005-04-18	
Jen-Yuan Wu	2005-04-18	

RECEIVING PARTY DATA

Name	Street Address	Internal Address	City	State/Country	Postal Code
MICROELECTRONICS	No.3, Li-Hsin Road 2, Science-Based Industrial Park		Hsin-Chu City	TAIWAN	

CORRESPONDENCE DATA

FAX NUMBER: 8064986673

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.

CUSTOMER NUMBER: 027765

 NAME OF PERSON SIGNING:
 WINSTON HSU

 DATE SIGNED:
 2005-04-19

Total Attachments: 2

source=NAUP0690-0-A1ASS1.tif source=NAUP0690-0-A1ASS2.tif CH \$40.00 503105

PATENT REEL: 015924 FRAME: 0566

800017832

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

	Name:	Wei-Chi Ting	Nationali	ty: R.O.C.		
	Address:	No. 22, Lane 135, Yushan St., Chiali Town, Tainan Hsien, Taiwan, R.O.C.				
	Name:	Jen-Yuan Wu	Nationali	ty: R.O.C.		
	Address:	No.3-1, Tiansin, Tiansin Villa	ge, Gukeng Township, Yun	-Lin Hsien, Taiwan, R.O.C		
Here	by sells, as	ssigns and transfers to				
ASSI	IGNEE(S)	: :				
	Name:	UNITED MICROELECTRON	NICS CORP.			
	Address: No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City, Taiwa					
	and all imp	sors and assignees of the ASSI provements which are disclosed D FOR FABRICATING TRENCH	l in the invention entitled:	e, and interest in and to		
Whi	ich is foun	d in :				
(a) _	_	U.S. patent application execute	d on even date			
(b)		U.S. patent application executed on				
(c)_	1	U.S. application serial no				
(d)_	F	eatent no i	ssued	·		

ASSIGNOR(S) (Inventors):

REEL: 015924 FRAME: 0567

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We has signing). (清發明人務必簽署上列日期。)	we hereunto set hand and seal this	APR 1 8 2005 (Date of
(Type name of inventor)	Signature of INVENTOR	
Wei-Chi Ting	Wich Tip	
<u>Jen-Yuan Wu</u>	Juan - Yuan Wu	